

# TLP759F

Digital Logic Ground Isolation  
 Line Receiver  
 Microprocessor System Interfaces  
 Switching Power Supply Feedback Control  
 Industrial Inverter

The TOSHIBA TLP759F consists of a high-output infrared emitting diode and a high speed detector of one chip photo diode-transistor. This unit is 8-lead DIP.

TLP759F has no internal base connection, and a Faraday shield integrated on the photodetector chip provides an effective common mode noise transient immunity.

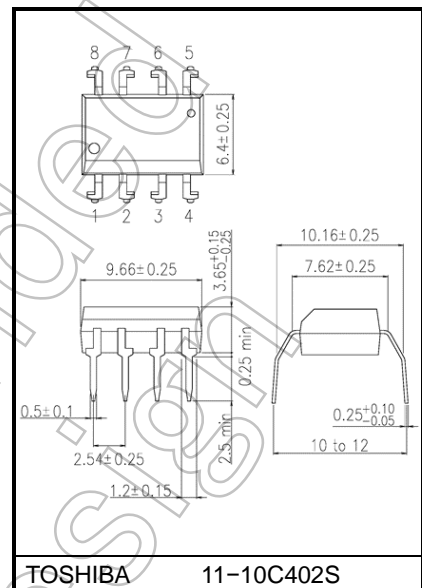
So this is suitable for application in noisy environmental condition.

- Isolation voltage: 5000 Vrms (min)
- Switching speed:  $t_{pHL} = 0.2\mu s$  (typ.)  
 $t_{pLH} = 0.3\mu s$  (typ.) ( $R_L=1.9 k\Omega$ )
- TTL compatible
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A  
 File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

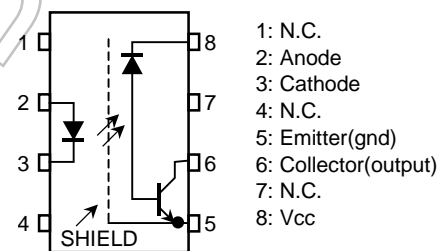
Note 1: When a VDE approved type is needed, please designate the **Option (D4)**.

- Mechanical Parameters  
 Creepage distance: 8.0 mm (min)  
 Clearance: 8.0 mm (min)  
 Insulation thickness: 0.4 mm (min)

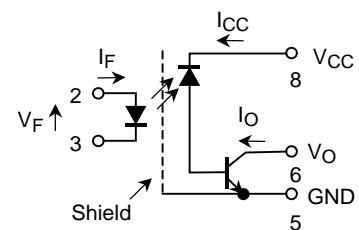
Unit: mm



### Pin Configuration (top view)



### Schematic



Start of commercial production  
 1995-08

## Absolute Maximum Ratings (Ta = 25°C)

| Characteristic                                     |  | Symbol              | Rating     | Unit             |
|--|--|---------------------|------------|------------------|
| LED  | Forward current                              | I <sub>F</sub>      | 25         | mA               |
|  | Forward current derating (Ta ≥70°C)          | I <sub>F</sub> / Ta | -0.8       | mA / °C          |
|  | Pulse forward current (Note 1)               | I <sub>FP</sub>     | 50         | mA               |
|  | Peak transient forward current (Note 2)      | I <sub>FPT</sub>    | 1          | A                |
|  | Reverse voltage                              | V <sub>R</sub>      | 5          | V                |
|  | Diode power dissipation (Note 3)             | P <sub>D</sub>      | 45         | mW               |
| Detector   | Output current                               | I <sub>O</sub>      | 8          | mA               |
|  | Peak output current                          | I <sub>OP</sub>     | 16         | mA               |
|  | Output voltage                               | V <sub>O</sub>      | -0.5 to 20 | V                |
|  | Supply voltage                               | V <sub>CC</sub>     | -0.5 to 30 | V                |
|  | Output power dissipation                     | P <sub>O</sub>      | 100        | mW               |
|  | Output power dissipation derating (Ta ≥70°C) | P <sub>O</sub> / Ta | -2         | mW / °C          |
| Operating temperature range                        |  | T <sub>opr</sub>    | -55 to 100 | °C               |
| Storage temperature range                          |  | T <sub>stg</sub>    | -55 to 125 | °C               |
| Lead solder temperature (10 s) (Note 4)            |  | T <sub>sol</sub>    | 260        | °C               |
| Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 5) |  | B <sub>Vs</sub>     | 5000       | V <sub>rms</sub> |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50 % duty cycle, 1 ms pulse width. Derate 1.6 mA / °C above 70 °C.

(Note 2) Pulse width ≤ 1 μs, 300 pps.

(Note 3) Derate 0.9 mW / °C above 70 °C.

(Note 4) Soldering portion of lead: Up to 2 mm from the body of the device.

(Note 5) Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

## Electrical Characteristics (Ta = 25°C)

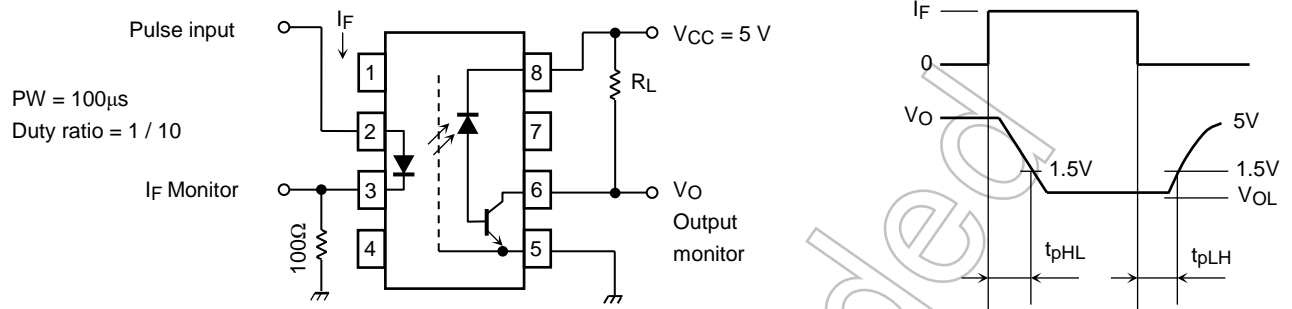
| Characteristic |   | Symbol                          | Test Condition   | Min                  | Typ.             | Max  | Unit             |
|----------------|---|---------------------------------|--|----------------------|------------------|------|------------------|
| LDE            | Forward voltage                         | V <sub>F</sub>                  | I <sub>F</sub> = 16 mA   | —                    | 1.65             | 1.85 | V                |
|                | Forward voltage temperature coefficient | ΔV <sub>F</sub> / ΔTa           | I <sub>F</sub> = 16 mA   | —                    | -2               | —    | mV / °C          |
|                | Reverse current                         | I <sub>R</sub>                  | V <sub>R</sub> = 5 V   | —                    | —                | 10   | μA               |
|                | Capacitance between terminals           | C <sub>T</sub>                  | V = 0 V, f = 1 MHz   | —                    | 45               | —    | pF               |
| Detector       | High level output current               | I <sub>OH</sub> (1)             | I <sub>F</sub> = 0 mA, V <sub>CC</sub> = V <sub>O</sub> = 5.5 V                    | —                    | 3                | 500  | nA               |
|                |   | I <sub>OH</sub> (2)             | I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 30 V, V <sub>O</sub> = 20 V               | —                    | —                | 5    | μA               |
|                |   | I <sub>OH</sub>                 | I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 30 V, V <sub>O</sub> = 20 V<br>Ta = 70 °C | —                    | —                | 50   |                  |
|                | High level supply current               | I <sub>CCH</sub>                | I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 30 V                                      | —                    | 0.01             | 1    | μA               |
| Coupled        | Current transfer ratio                  | I <sub>O</sub> / I <sub>F</sub> | I <sub>F</sub> = 16 mA, V <sub>CC</sub> = 4.5 V<br>V <sub>O</sub> = 0.4 V          | 20                   | 40               | —    | %                |
|                | Low level output voltage                | V <sub>OL</sub>                 | I <sub>F</sub> = 16 mA, V <sub>CC</sub> = 4.5 V<br>I <sub>O</sub> = 2.4 mA         | —                    | —                | 0.4  | V                |
|                | Resistance (input-output)               | R <sub>S</sub>                  | R.H. ≤ 60 %, V <sub>S</sub> = 500 V (Note 5)                                       | 1 × 10 <sup>12</sup> | 10 <sup>14</sup> | —    | Ω                |
|                | Capacitance (input-output)              | C <sub>S</sub>                  | V <sub>S</sub> = 0 V, f = 1 MHz (Note 5)   | —                    | 0.8              | —    | pF               |
|                | Isolation voltage                       | B <sub>V</sub> S                | AC, 60 s (Note 5)  | 5000                 | —                | —    | V <sub>rms</sub> |

## Switching Characteristics (Ta = 25°C, VCC = 5V)

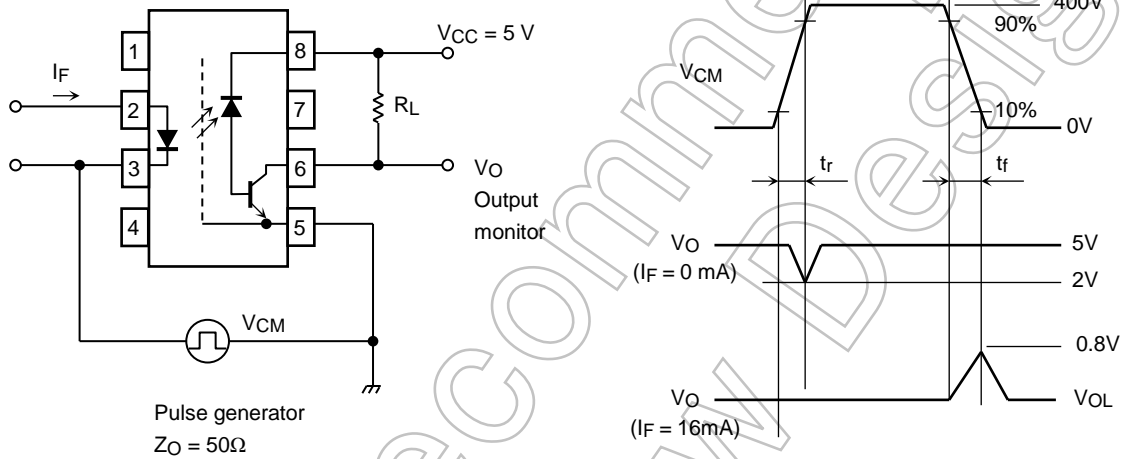
| Characteristic   | Symbol           | Test Circuit | Test Condition   | Min   | Typ.  | Max    | Unit   |
|--|------------------|--------------|--|---|-------|--------|--------|
| Propagation delay time (H → L)                               | t <sub>pHL</sub> | 1            | I <sub>F</sub> = 0 → 16 mA,<br>R <sub>L</sub> = 1.9 kΩ                                   | —   | 0.2   | 0.8    | μs     |
| Propagation delay time (L → H)                               | t <sub>pLH</sub> |              |  | I <sub>F</sub> = 16 → 0 mA,<br>R <sub>L</sub> = 1.9 kΩ                                    | —     | 0.3    | 0.8    |
| Common mode transient immunity at logic high output (Note 1) | CM <sub>H</sub>  | 2            | I <sub>F</sub> = 0 mA, V <sub>CM</sub> = 400 V <sub>p-p</sub><br>R <sub>L</sub> = 4.1 kΩ | 5000  | 10000 | —      | V / μs |
| Common mode transient immunity at logic low output (Note 1)  | CM <sub>L</sub>  |              |  | I <sub>F</sub> = 16 mA, V <sub>CM</sub> = 400 V <sub>p-p</sub><br>R <sub>L</sub> = 4.1 kΩ | -5000 | -10000 | —      |

(Note 1) CML is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state (V<sub>O</sub> < 0.8 V).  
CMH is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state (V<sub>O</sub> > 2.0 V).

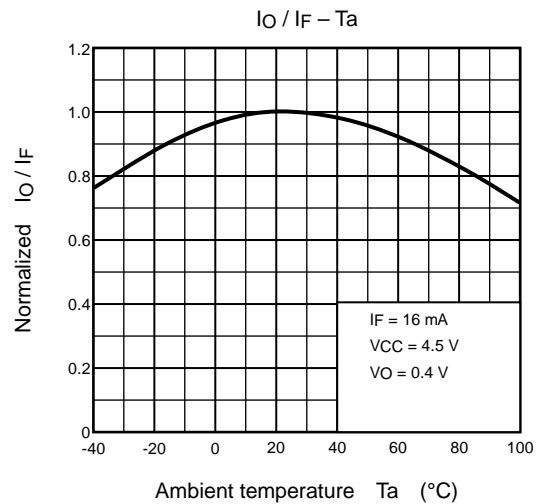
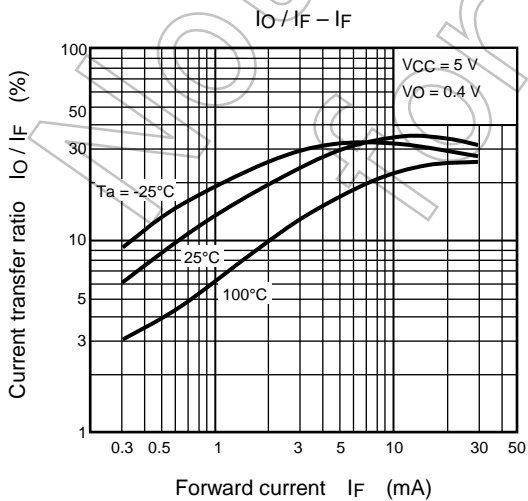
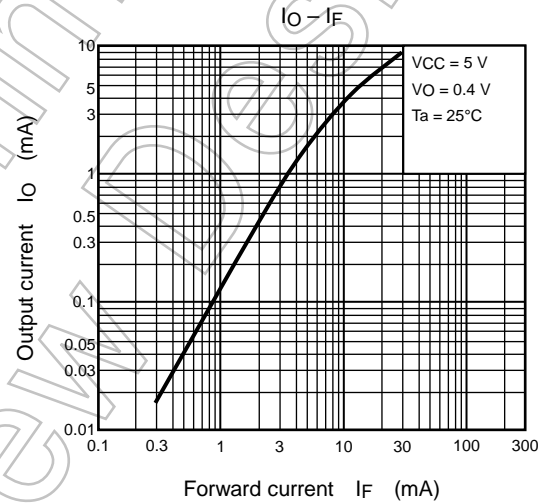
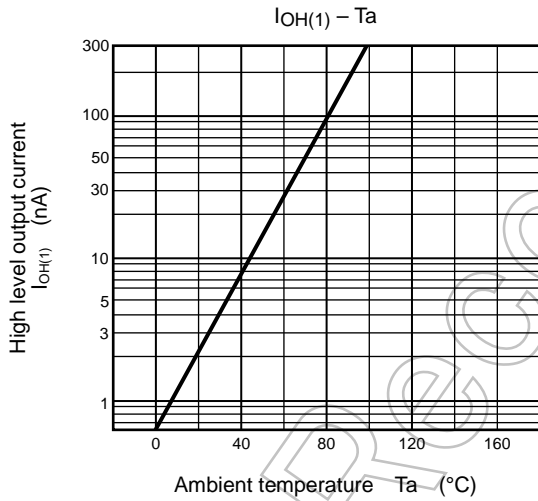
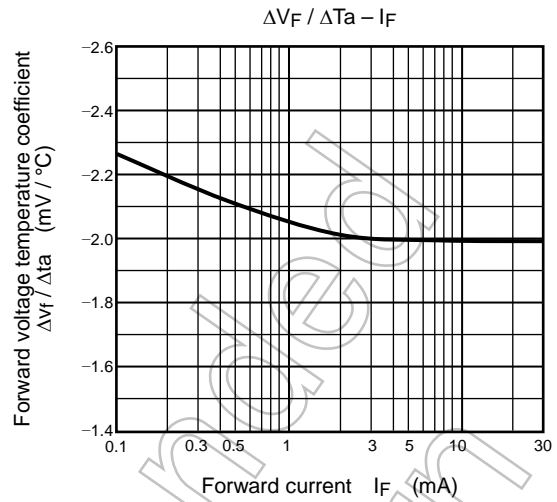
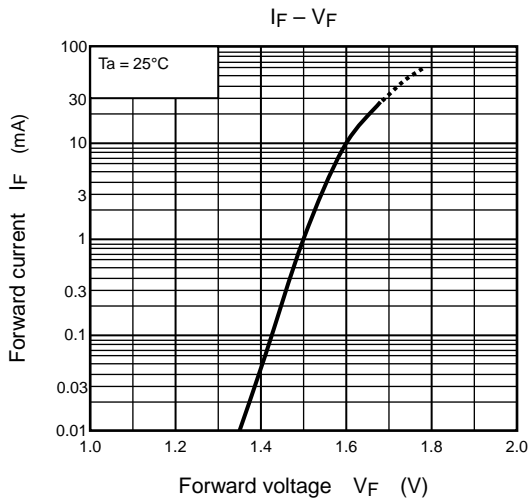
## Test Circuit 1: Switching Time Test Circuit



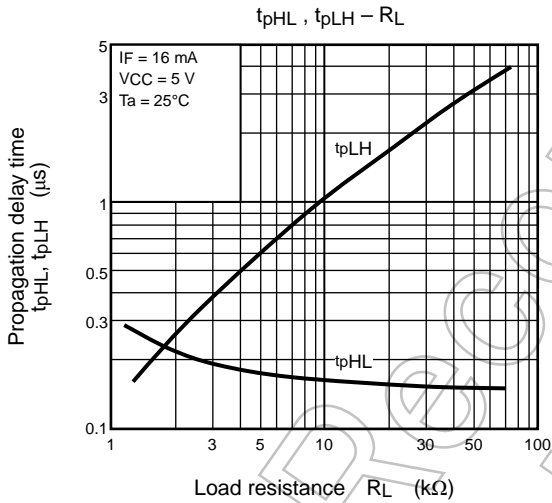
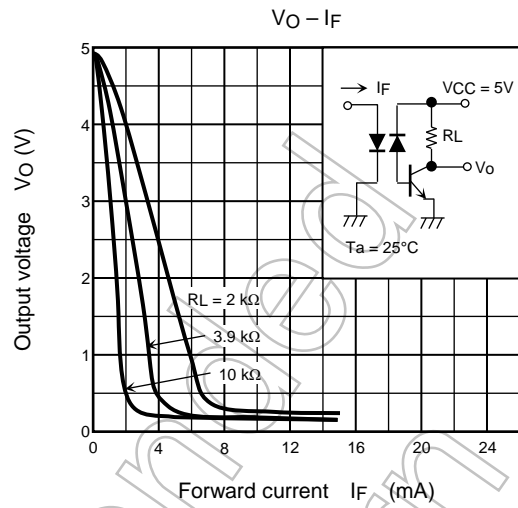
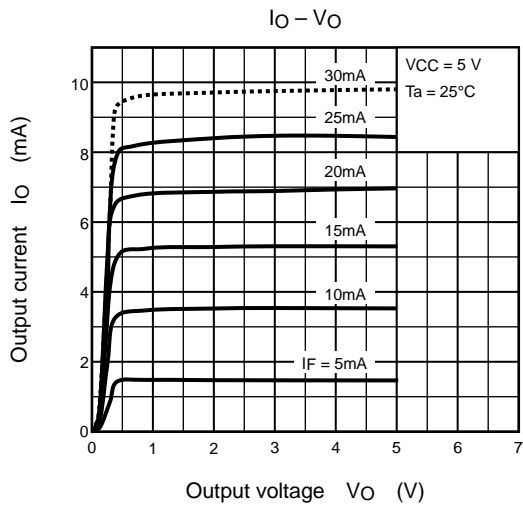
## Test Circuit 2: Common Mode Noise Immunity Test Circuit



$$CM_{IH} = \frac{320\text{ (V)}}{t_r\text{ (\mu s)}}, CM_{IL} = \frac{320\text{ (V)}}{t_f\text{ (\mu s)}}$$



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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